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Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

## Details

Product Status	Obsolete
Core Processor	HC08
Core Size	8-Bit
Speed	6MHz
Connectivity	SCI, USB
Peripherals	LED, LVD, POR, PWM
Number of I/O	13
Program Memory Size	12KB (12K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	384 x 8
Voltage - Supply (Vcc/Vdd)	4V ~ 5.5V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	20-SOIC (0.295", 7.50mm Width)
Supplier Device Package	20-SOIC
Purchase URL	https://www.e-xfl.com/product-detail/nxp-semiconductors/mc68hc908jb12jdw

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong



Freescale Semiconductor Application Note

Document Number: HC908JB16AD/D Rev. 1, 03/2010

# Addendum to MC68HC908JB16 Technical Data

This addendum provides update and additional information to the *MC68HC908JB16 Technical Data*, Rev. 1.1 (Freescale document number MC68HC908JB16/D).

pertaining to the following:

- MC68HC908JB16
  - Update to V<sub>REG</sub> LVI trip point
  - 20-pin SOIC package
- MC68HC908JB12

# MC68HC908JB16

This section updates data sheet information and introduces the 20-pin SOIC package for the MC68HC908JB16. These updates apply to the 20-pin SOIC only.

V<sub>REG</sub> LVI Trip Point Page 318, entry for minimum V<sub>REG</sub> LVI trip point voltage has been updated.

Characteristic	Symbol	Min	Тур	Мах	Unit
V <sub>REG</sub> LVI trip point voltage	V <sub>LVR</sub>	2.0	2.2	2.6	V

1	0:

From:

V <sub>REG</sub> LVI trip point voltage	V <sub>LVR</sub>	1.9	2.2	2.6	V
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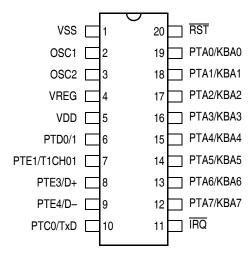
**Output Low Voltage** Page 318, entry for maximum V<sub>OL</sub> has been updated.

From:					
Characteristic	Symbol	Min	Тур	Max	Unit
Output low voltage (I <sub>Load</sub> = 25 mA) PTD0–PTD1 in ILDD mode	V <sub>OL</sub>	_	_	0.5	V

То:						
Output low voltage (I <sub>Load</sub> = 45 mA) PTD0/1 in ILDD mode	V <sub>OL</sub>	_	_	0.5	V	

20-Pin SOIC

## Order Number: MC68HC908JB16JDW



Pins not available on 20-pin package:				
PTC1/RxD	PTE0/TCLK	PTD2		
	PTE2/T2CH01	PTD3		
CGMXFC1	CGMXFC2	PTD4		
CGMOUT1	CGMOUT2	PTD5		
VREGA0	VREGA1			
VSSA0	VSSA1	VDDA		

Internal pads are unconnected.

PTD0/1 pin: PTD0 and PTD1 internal pads are bonded together to PTD0/1 pin. PTD0/1 has a 45 mA sink capability when configured as an output. Pin direction must be configured such that DDRD0 = DDRD1.





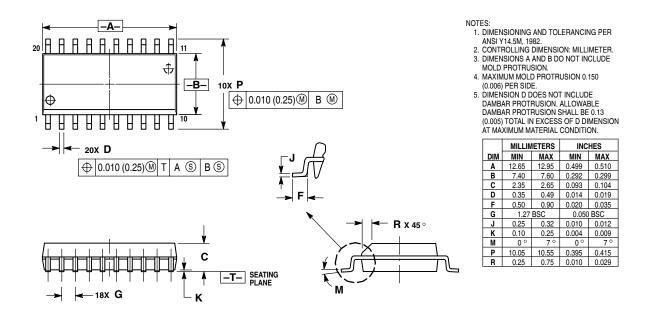


Figure 2. 20-Pin SOIC Mechanical Dimensions (Case No. 751D)



This section introduces the MC68HC908JB12, a derivative of the MC68HC908JB16. The entire MC68HC908JB16 data book, including the updates in this addendum, applies to this device, with exceptions outlined below.

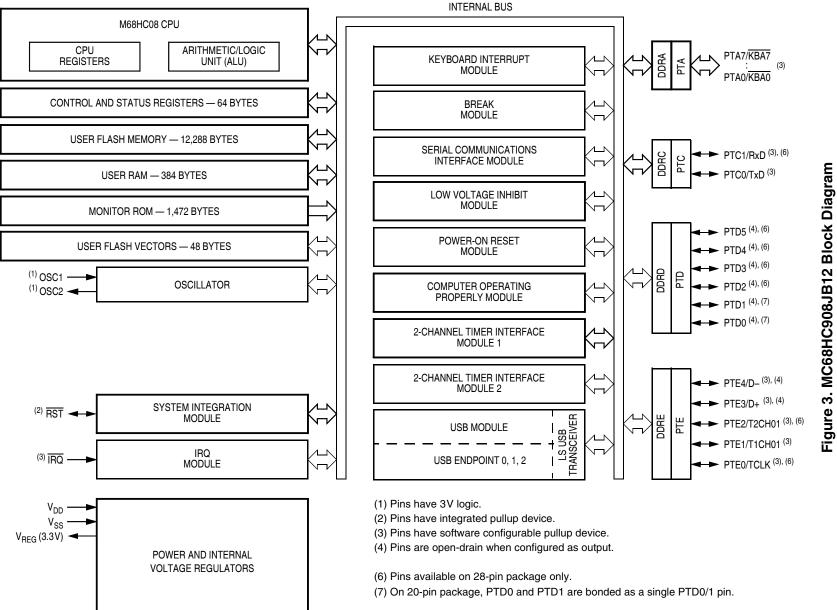
# Table 1. Summary of MC68HC908JB12 and MC68HC908JB16 Differences

	MC68HC908JB12	MC68HC908JB16
FLASH Memory	12,288 bytes (\$CA00–\$F9FF)	16,384 bytes (\$BA00–\$F9FF)
Dual Clock Generator Module	Not implemented. \$0051–\$0059 unimplemented.	Yes
Available Packages <sup>(1)</sup>	— 28-pin SOIC 20-pin SOIC	32-pin LQFP 28-pin SOIC 20-pin SOIC

1. The pin assignments are identical for both devices; see data sheet.

MCU Block Diagram	Figure 3 shows the structure of the MC68HC908JB12.
Memory Map	Figure 4 shows the memory map of the MC68HC908JB12.
Dual Clock Generator Module	The dual 27-MHz clock generator module on the MC68HC908JB16 is not designed in the MC68HC908JB12, hence, register locations from \$0051 to \$0059 are unimplemented. Information in the data book relating to the CGM do not apply to the MC68HC908JB12.





**ю**. Figure (



\$0000	I/O Pagiatara
↓ \$007F	I/O Registers 128 Bytes
\$0080	
$\downarrow$	RAM 294 Butes
\$01FF	384 Bytes
\$0200 I	Unimplemented
\$C9FF	51,200 Bytes
\$CA00	FLASH Memory
↓ \$F9FF	12,288 Bytes
\$FA00	
$\downarrow$	Monitor ROM 1
\$FDFF	1,024 Bytes
\$FE00	SIM Break Status Register (SBSR)
\$FE01	SIM Reset Status Register (SRSR)
\$FE02	Reserved
\$FE03	SIM Break Flag Control Register (SBFCR)
\$FE04	Interrupt Status Register 1 (INT1)
\$FE05	Interrupt Status Register 2 (INT2)
\$FE06	Reserved
\$FE07	Reserved
\$FE08	FLASH Control Register (FLCR)
\$FE09	FLASH Block Protect Register (FLBPR)
\$FE0A	Reserved
\$FE0B	Reserved
\$FE0C	Break Address Register High (BRKH)
\$FE0D	Break Address Register Low (BRKL)
\$FE0E	Break Status and Control Register (BRKSCR)
\$FE0F	Reserved
\$FE10	Monitor ROM 2
↓ \$FFCF	448 Bytes
\$FFD0	EL ASH Vastoro
$\downarrow$	FLASH Vectors 48 Bytes
\$FFFF	

Figure 4. MC68HC908JB12 Memory Map

Addendum to MC68HC908JB16 Technical Data, Rev. 1



## Pullup on PTE3/D+ and PTE4/D– Pins

On the MC68HC908JB12, control over the pullup devices on PTE3/D+ and PTE4/D– pins are shown in **Table 2**.

PULLEN (\$001A)	USBEN (\$0038)	PTExP (\$001D)	PTE4IE (\$001C)	PTE3/D+ pin	PTE4/D– pin
0	0	0	0	—	—
0	0	1	0	$5 k\Omega$ pullup to V <sub>DD</sub>	$5k\Omega$ pullup to V <sub>DD</sub>
0	0	0	1	—	5k $\Omega$ pullup to V <sub>DD</sub> <sup>(1)</sup>
0	0	1	1	$5 k\Omega$ pullup to V <sub>DD</sub>	5k $\Omega$ pullup to V <sub>DD</sub> <sup>(1)</sup>
0	1	Х	Х	—	—
1	1	Х	Х	—	1.5 k $\Omega$ pullup to $V_{REG}$
1	0	Х	0	—	1.5k $\Omega$ pullup to V <sub>REG</sub>
1	0	Х	1	Do not set this	configuration.

Table 2. Pullup Control on PTE3/D+ and PTE4/D– Pins

1. External interrupt function is also enabled on PTE4/D- pin.

ElectricalElectrical specifications for the MC68HC908JB16 apply to theSpecificationsMC68HC908JB12, except for the USB reset timing:

Bus State		Signaling Levels
Bus State	Transmit	Receive
Reset	NA	D+ and D- < V <sub>IL</sub> (max) for $\geq$ 8µs (MC68HC908JB16) D+ and D- < V <sub>IL</sub> (max) for $\geq$ 125µs (MC68HC908JB12)

Order Numbers

These are MC order numbers for MC68HC908JB12.

## Table 3. MC68HC908JB12 Order Numbers

MC Order Number	Package	Operating Temperature Range
MC68HC908JB12JDW	20-pin SOIC	0 °C to +70 °C
MC68HC908JB12DW	28-pin SOIC	0 °C to +70 °C



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